Docket No. 217713US2

IN RE APPLICATION OF: Jun TATSUTA, et al.

SERIAL NO: 10/026,639

FILED:

December 27, 2001

FOR:

SEMICONDUCTOR-CHIP MOUNTING SUBSTRATE AND METHOD OF MANUFACTURING THE SAME

3877\$

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Transmitted herewith is an amendment in the above-identified application.

- ☐ No additional fee is required
- ☐ Small entity status of this application under 37 C.F.R. §1.9 and §1.27 is claimed.
- Additional documents filed herewith: Letter Submitting Drawing Replacement Sheet with 1 Attachment

The Fee has been calculated as shown below:

CLAIMS	CLAIMS REMAINING		HIGHEST NUMBER PREVIOUSLY PAID	NO. EXTRA CLAIMS		RATE		CALCULATIONS
TOTAL	22	MINUS	26	0	х	\$18	=	\$0.00
INDEPENDENT	5	MINUS	3	2	x	\$84	=	\$168.00
☐ MULTIPLE DEPENDENT CLAIMS + \$280 =						=	\$0.00	
TOTAL OF ABOVE CALCULATIONS						NS	\$168.00	
☐ Reduction by 50% for filing by Small Entity							\$0.00	
☐ Recordation of Assignment + \$40					=	\$0.00		
						TOT	AL	\$168.00

- A check in the amount of \$168.00 is attached.
- Please charge any additional Fees for the papers being filed herewith and for which no check is enclosed herewith, or credit any overpayment to deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.
- If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136, and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

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(OSMMN 05/03)

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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

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Jun TATSUTA, et al.

GROUP: 2827

SERIAL NO: 10/026,639

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FILED: December 27, 2001

EXAMINER: CRUZ, L.

FOR: SEMICONDUCTOR-CHIP

MOUNTING SUBSTRATE AND METHOD OF MANUFACTURING

THE SAME

AMENDMENT

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

In response to the Office Action dated March 11, 2002, please consider the remarks below and amend the above-identified patent application as follows:

Amendments to the specification begin on page 2 of this paper.

Amendments to the claims begin on page 4 of this paper.

Amendments to the drawings begin on page 13 of this paper and include an attached replacement sheet.

Remarks begin on page 14 of this paper.

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